Power MOSFET

40 V, 38 A, Single N-Channel, DPAK

Features

- Low R_{DS(on)}
- High Current Capability
- Low Gate Charge
- These are Pb-Free Devices

Applications

- Electronic Brake Systems
- Electronic Power Steering
- Bridge Circuits

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

| Parameter | | | Symbol | Value | Units |
|--|------------------|------------------------|--------------------------------------|---------------|-------|
| Drain-to-Source Voltage | | | V _{DSS} | 40 | V |
| Gate-to-Source Voltage | е | | V_{GS} | ±20 | V |
| Continuous Drain | Steady | $T_C = 25^{\circ}C$ | I _D | 38 | Α |
| Current – R _{0JC} (Note 1) | State | T _C = 100°C | | 27 | |
| Power Dissipation – R _{θJC} (Note 1) | Steady State | | | 75 | W |
| Pulsed Drain Current | t _p = | = 10 μs | I _{DM} | 75 | Α |
| Operating Junction and Storage Temperature | | | T _J , T _{STG} | –55 to 175 | °C |
| Source Current (Body Diode) | | | IS | 36 | Α |
| Single Pulse Drain–to Source Avalanche Energy – (V_{DD} = 50 V, V_{GS} = 10 V, I_{PK} = 17 A, L = 1 mH, R_G = 25 Ω) | | | EAS | 150 | mJ |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | T _L | 260 | °C |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS (Note 1)

| Parameter | Symbol | Max | Units |
|--------------------------|-----------------|-----|-------|
| Junction-to-Case (Drain) | $R_{\theta JC}$ | 2.0 | °C/W |

Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

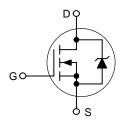


ON Semiconductor®

http://onsemi.com

| V _{(BR)DSS} | R _{DS(ON)} TYP | I _D MAX (Note 1) | |
|----------------------|-------------------------|--------------------------------|--|
| 40 V | 21 mΩ @ 10 V | 38 A | |

N-Channel





DPAK CASE 369C STYLE 2

DIAGRAM 1

MARKING



Y = Year WW = Work Week

5407N = Specific Device Code G = Pb-Free Device

ORDERING INFORMATION

| Device | Package | Shipping† |
|-------------|-------------------|--------------------|
| NTD5407NG | DPAK (Pb-Free) | 75 Units / Rail |
| NTD5407NT4G | DPAK (Pb-Free) | 2500 / Tape & Reel |

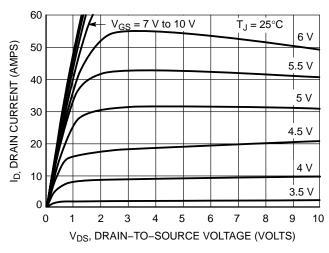
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise stated)

| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|--------------------------------------|--|---------------------------|-----|------|------|-------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 40 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} /T _J | | | | 39 | | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, | T _J = 25°C | | | 1.0 | μΑ |
| | | $V_{DS} = 40 \text{ V}$ | T _J = 100°C | | | 10 | |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} = ±30 V | | | | ±100 | nA |
| ON CHARACTERISTICS (Note 2) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_{E}$ | ο = 250 μΑ | 1.5 | | 3.5 | V |
| Gate Threshold Temperature Coefficient | V _{GS(TH)} /T _J | | | | -6.0 | | mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V, | I _D = 20 A | | 21 | 26 | mΩ |
| | | $V_{GS} = 5.0 \text{ V},$ | I _D = 10 A | | 32 | 40 | |
| Forward Transconductance | 9FS | V _{GS} = 10 V, | I _D = 18 A | | 15 | | S |
| CHARGES AND CAPACITANCES | | | • | | • | • | • |
| Input Capacitance | C _{ISS} | | | | 615 | 1000 | pF |
| Output Capacitance | C _{OSS} | $V_{GS} = 0 \text{ V, f} = V_{DS} = 3$ | : 1.0 MHz, | | 173 | | |
| Reverse Transfer Capacitance | C _{RSS} | VDS - V | 52 V | | 80 | | |
| Total Gate Charge | Q _{G(TOT)} | | | | 20 | | nC |
| Gate-to-Source Charge | Q _{GS} | $V_{GS} = 10 \text{ V}, V_{DS} = 32 \text{ V},$ $I_{D} = 38 \text{ A}$ | | | 2.25 | | |
| Gate-to-Drain Charge | Q_{GD} | | | | 10.5 | | |
| SWITCHING CHARACTERISTICS, V | GS = 10 V (Note | 3) | | | | | |
| Turn-On Delay Time | t _{d(ON)} | | | | 6.8 | | ns |
| Rise Time | t _r | V _{GS} = 10 V, V | nn = 32 V, | | 17 | | |
| Turn-Off Delay Time | t _{d(OFF)} | $I_D = 38 \text{ A, R}$ | $_{\rm G}$ = 2.5 Ω | | 66 | | |
| Fall Time | t _f | | | | 51 | | |
| SWITCHING CHARACTERISTICS, V | GS = 5 V (Note 3 |) | • | | • | • | • |
| Turn-On Delay Time | t _{d(ON)} | | | | 10 | | ns |
| Rise Time | t _r | V _{GS} = 5 V, V _E | on = 20 V. | | 175 | | |
| Turn-Off Delay Time | t _{d(OFF)} | $I_D = 20 \text{ A, R}$ | $_{\rm G}$ = 2.5 Ω | | 13 | | |
| Fall Time | t _f | | | | 23 | | |
| DRAIN-SOURCE DIODE CHARACT | ERISTICS (Note | 2) | • | | • | • | • |
| Forward Diode Voltage | V_{SD} | Vcs = 0 V | T _J = 25°C | | 0.9 | 1.1 | V |
| | | $V_{GS} = 0 \text{ V},$ $I_{J} = 25$ $T_{J} = 125$ | | | 0.75 | | |
| Reverse Recovery Time | t _{RR} | $V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 15 \text{ A}$ | | | 38 | | ns |
| Charge Time | ta | | | | 20.5 | | 1 |
| Discharge Time | t _b | | | | 17 | | 1 |
| Reverse Recovery Charge | Q _{RR} | | | | 40 | | nC |

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

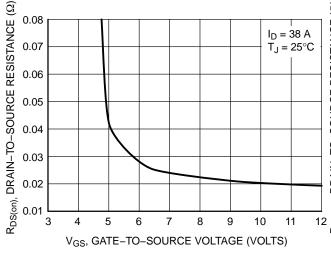
TYPICAL PERFORMANCE CURVES



60 $V_{DS} \ge 10 \text{ V}$ ID, DRAIN CURRENT (AMPS) 50 40 30 20 $T_J = 100^{\circ}C$ 10 $T_J = 25^{\circ}C$ $T_J = -55^{\circ}C$ 0 0 2 3 5 6 8 V_{GS}, GATE-TO-SOURCE VOLTAGE (VOLTS)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



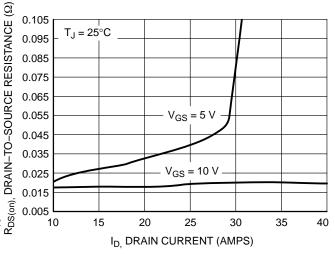
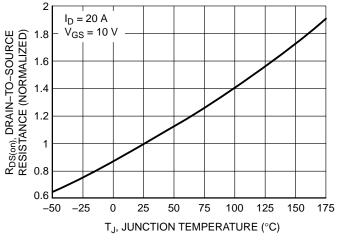


Figure 3. On-Resistance vs. Gate-to-Source Voltage

Figure 4. On–Resistance vs. Drain Current and Gate Voltage



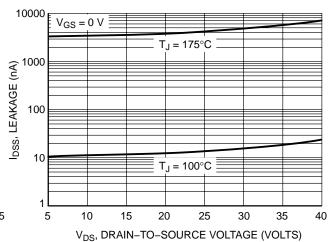
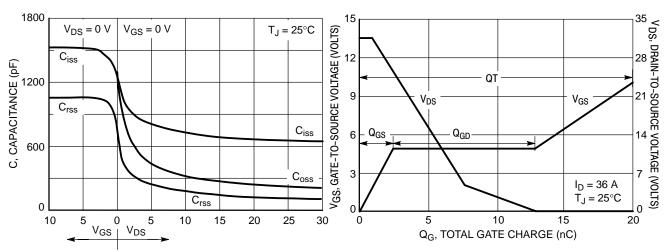


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL PERFORMANCE CURVES



GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 7. Capacitance Variation

Figure 8. Gate-To-Source and Drain-To-Source Voltage vs. Total Charge

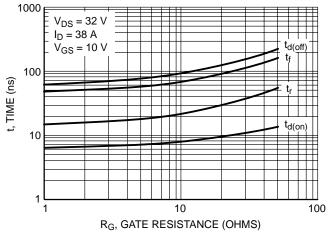


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

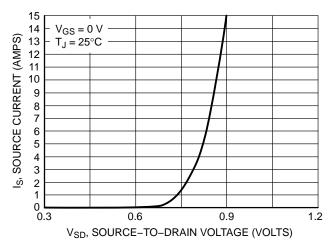
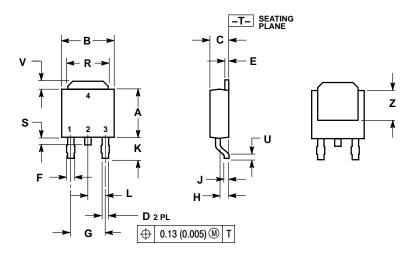


Figure 10. Diode Forward Voltage vs. Current

PACKAGE DIMENSIONS

DPAK CASE 369C-01 **ISSUE O**

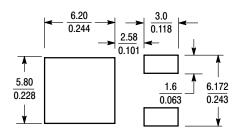


- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

| | INCHES | | MILLIMETERS | | |
|-----|-----------|-------|-------------|------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.235 | 0.245 | 5.97 | 6.22 | |
| В | 0.250 | 0.265 | 6.35 | 6.73 | |
| С | 0.086 | 0.094 | 2.19 | 2.38 | |
| D | 0.027 | 0.035 | 0.69 | 0.88 | |
| E | 0.018 | 0.023 | 0.46 | 0.58 | |
| F | 0.037 | 0.045 | 0.94 | 1.14 | |
| G | 0.180 | BSC | 4.58 BSC | | |
| Н | 0.034 | 0.040 | 0.87 | 1.01 | |
| J | 0.018 | 0.023 | 0.46 | 0.58 | |
| K | 0.102 | 0.114 | 2.60 | 2.89 | |
| L | 0.090 BSC | | 2.29 | BSC | |
| R | 0.180 | 0.215 | 4.57 | 5.45 | |
| S | 0.025 | 0.040 | 0.63 | 1.01 | |
| U | 0.020 | | 0.51 | | |
| V | 0.035 | 0.050 | 0.89 | 1.27 | |
| Z | 0.155 | | 3.93 | | |

STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

SOLDERING FOOTPRINT*



^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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